

# PLM Components Innovation Conference



## 2026 Event Guide

April 28-29, 2026

Downing College, Cambridge | UK

**SIEMENS**

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# About

## PLM Components Innovation Conference

It's where Siemens comes together with customers, partners and analysts to explore the wide range of applications of our open PLM Components portfolio, to assure success for our software vendor ecosystem and its end-users.

### At the conference, you will:

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Listen to 30+ inspiring speakers from top CAD, CAM, CAE and AEC companies

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Discuss AI, security, DevOps, cloud & more

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Network with industry experts, CxOs and product development leaders

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Learn about the vision and roadmap for PLM Components from Siemens executives



The PLM Components conference was a great place to see the impact Siemens has on the PLM market. Their products enable many companies to better meet their customers' needs."

Tom Gill, Principal consultant, CIMdata

2024 PLM Components Innovation Conference speaker



## Experience at a glance

# Developing next-generation software for 3D product design, simulation or manufacturing? This is the conference for you.

The event will showcase the latest developments in design, manufacturing, simulation, robotics and interoperability software. Together with established vendors as well as start-ups integrating PLM Components, we will discuss how this open portfolio of software development kits enables them to deliver leading solutions.

2  
Days

150  
Attendees

40+  
Customers and Partners

25+  
Sessions

Networking events  
throughout



### Customer success stories

Learn how software vendors create value with PLM Components



### Industry trends

AI, digitalization, sustainability, cloud, metaverse and more



### Insights and best practices

Learn from PLM Components product experts and customers about optimizing solution implementation



### Meet product and business experts

Discuss your applications and business goals for PLM Components with our experts



### Professional networking

Network with an outstanding line-up of CxOs and VPs from our PLM Components customer base



### Product news and updates

Hear about the latest PLM Components product updates and development direction

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## What you will hear

# Visionary leaders will share insights on delivering innovation and discuss the future of the industry



**Openness**



**Digitalization**



**Partnership**



**3D Data  
ecosystem**



**Artificial Intelligence**

AI is changing how products are conceived, designed, analyzed and manufactured. The CAx software industry needs to rapidly evolve to support intelligent, autonomous and highly optimized engineering processes. PLM Components are the software components of choice for AI applications.



**Broadening Paradigms of  
Geometry Representation**

Data representation in CAD has broadened beyond traditional boundary representation (B-rep), reflecting the growing diversity of design and manufacturing needs. By leveraging this plurality of paradigms and offering a unified modeling environment, CAD software will create more flexible designs and tighter integration between design, simulation and manufacturing.



## Who you will meet

### Thought leaders

Engage in meaningful conversations on the latest industry trends and challenges with industry executives and experts, analysts and software development leaders.

### Product experts

Meet the Siemens product development leaders and teams, discuss best practices, implementation strategies, news and updates for PLM Components and the vision for the future of the portfolio.

### Peers

Interact with peers from all over the world as a member of the PLM Components customers and partners community.



# Speakers

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**Ambroise Confetti**  
Product owner  
Kineo components

**Bob Haubrock**  
Sr Vice President  
Product Engineering  
Software

**Peter Knight**  
Product manager  
D-Cubed components

**Phil Nanson**  
Director  
Parasolid components

**Giampaolo Pagnutti**  
Vice President  
Software  
Development  
Altair

**Dan Staples**  
Vice President  
Mainstream Engineering  
R&D

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## Customers, partners and analysts

**Michael Bogomolny**  
CEO  
Infinitform

**Simone Bonino**  
Global Product Director  
Cimatron, Sandvik group

**Mark Driscoll and  
Olexiy Kilyakov**  
Sr Director of Sales and  
Director of Tech. Sales  
AMC Bridge Inc.

**Jens Fetzer**  
SVP Digital Factory  
solutions  
CENIT

**Michael Finocchiaro**  
Sr. industry analyst  
Finocchiaro Consulting

**Tom Gill**  
Principal consultant  
CIMdata

**Jonathan Girroir**  
Sr. Director  
Toolkit marketing  
Tech Soft 3D

**Stephen Graham**  
Executive VP and GM  
Hexagon

**Paul Chastell**  
Technical VP, R&D  
Onshape  
PTC

**Chun Qing Li**  
CEO  
Kreodx

**Hugo Nordell**  
Founder and CEO  
Encube

**Bradley Rothenberg  
and George Allen**  
CEO and Fellow,  
nTop

**Andrew Sartorelli**  
Head of product  
management  
Synera

**Bart Van der Schueren**  
CSTO  
Materialise

**Kostadin Vrantzaliev**  
Founder  
Quicksurface

**Dan Watkins**  
Group Head of Digital  
Engineering Systems  
Red Bull Racing

**Al Whatmough**  
CEO  
Toolpath Labs



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# Agenda

## Monday 27 April

**Registration**  
03:00 PM – 05:00 PM

## Tuesday 28 April

**Registration**  
07:00 AM – 07:50 AM

**Welcome and Keynote**  
08:00 AM – 08:45 AM

**Main sessions**  
08:45 AM – 12:15 PM

**Break**  
10:15 AM

**Lunch**  
12:15 PM

**Panel discussion**  
01:15 PM – 2:15 PM

**Main sessions**  
02:15 PM – 05:15 PM

**Break**  
03:15 PM

**Adjourn day 1**  
05:15 PM

**Evening reception and dinner**  
07:00 PM

## Wednesday 29 April

**Registration**  
07:00 AM – 07:50 AM

**Main sessions**  
08:00 AM – 12:00 PM

**Break**  
10:00 AM

**Lunch**  
12:00 PM

**Panel discussion**  
01:00 PM – 02:00 PM

**Main sessions**  
02:00 – 04:30 PM

**Break**  
03:00 PM

**Adjourn day 2**  
04:30 PM

## Venue information

### We're in Cambridge!

The event will be held at Downing College, part of the University of Cambridge, UK, a historical location in the heart of the city.

Address: [Regent St, Cambridge CB2 1DQ, UK](#)

With its world-class computer science and engineering departments, the University of Cambridge was home to pioneering research that influenced both theoretical and practical aspects of geometric modeling

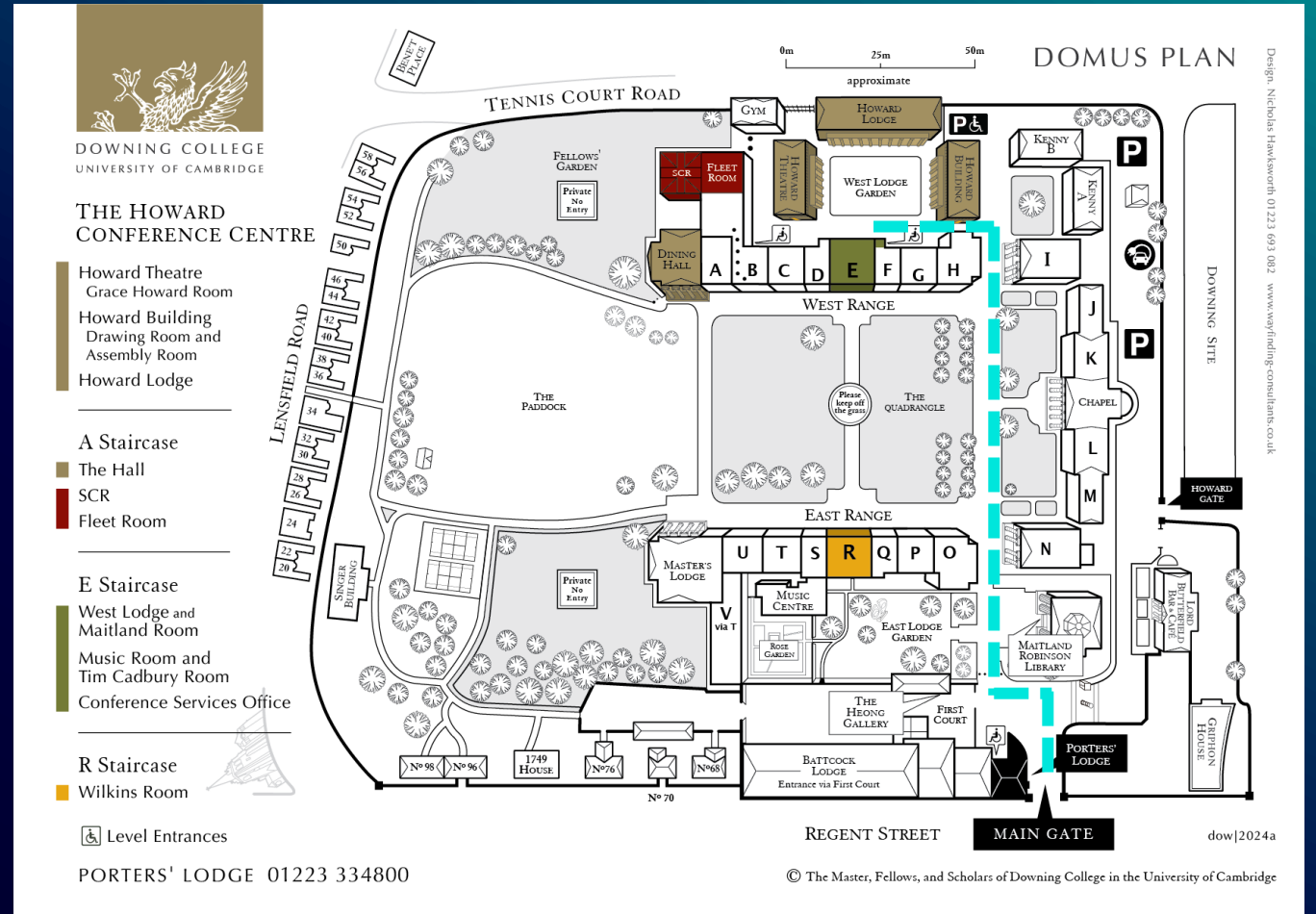
The venue is approximately 1m (1.6 Km) from Cambridge's train station – 7 mins by car or bus or 20 mins walk



# Venue information

## Venue map

The conference sessions, networking events and general reception will take place in the **Howard Conference Center** of Downing College, which can be reached from the main College entrance on [Regent street](#) as indicated in the map.



--- Directions to Howard Conference Center

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## Conference check-in

The check-in desk for the conference will be located in the **Grace Howard Room**, part of the Howard Conference Center in Downing College.

### Check-in opening times:

**Monday, April 27, from 3:00 PM until 5:00 PM**

**Tuesday, April 28, from 7:00 AM until 7:50 AM**

**Wednesday, April 29, from 7:00 AM until 7:50 AM**



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